

1. Features

- Typical 3dB bandwidth of 54.0 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

RoHS Compliant

Tested by SGS Testing Korea

2. Electrical Specifications

2-1 F₁ Electrical Specification

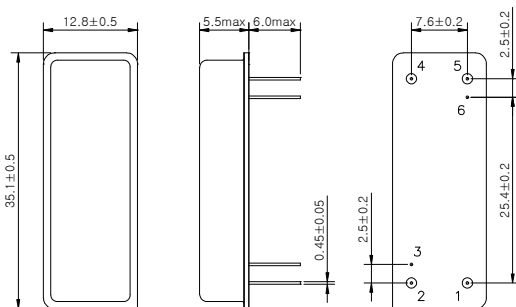
Room Temperature : +25°C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	109.25	109.4	109.55
Insertion Loss	dB	-	26.0	28.0
3dB Bandwidth	MHz	5.8	6.0	-
40dB Bandwidth	MHz	-	7.65	8.0
Amplitude Ripple (F ₁ ± 2.4 MHz)	dB	-	0.5	1.2
Group Delay Variation (F ₁ ± 2.4 MHz)	nsec	-	40	80
Absolute Delay (F ₁ ± F ₂)	usec	-	1.99	-
Ultimate Rejection	dB	45	50	-
Temperature Coefficient of Frequency	ppm/°C	-	-72	-

2-2 F₂ Electrical Specification

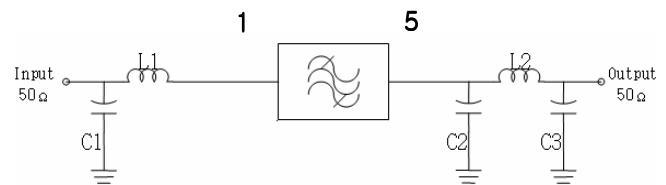
Room Temperature : +25°C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	161.55	161.7	161.85
Insertion Loss	dB	-	26.0	28.0
3dB Bandwidth	MHz	4.8	5.1	-
40dB Bandwidth	MHz	-	6.85	7.1
Amplitude Ripple (F ₁ ± 1.9 MHz)	dB	-	0.5	1.2
Group Delay Variation (F ₁ ± 1.9 MHz)	nsec	-	40	80
Absolute Delay (F ₁ ± F ₂)	usec	-	1.99	-
Ultimate Rejection	dB	40	45	-
Temperature Coefficient of Frequency	ppm/°C	-	-72	-

Input POWER : +10dBm

D3512 Package Dimension



Matching Schematic



L1 = 3.9nH, L2 = 15nH

C1 = 51pF, C2 = 20pF, C3 = 51pF

Pin Configuration

	1	Ground	2,4
Input	1	Ground	2,4
Output	5	Others	Ground

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated
Cap : Cu & Cr Alloy, Ni Plated
Termination : Kovar, Au Plated

3. Typical Performance (at +25°C)

